



60V N-Channel MOSFETs

General Description

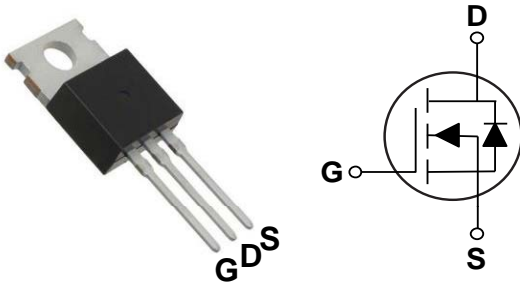
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV_{DSS}	R_{DS(ON)}	I_D
60 V	12 mΩ	55 A

Features

- 60V, 55A, R_{DS(ON)}=12mΩ @V_{GS}=10V
- Improved dv/dt capability
- Fast switching
- Green Device Available

TO-220 Pin Configuration



Applications

- Motor Drive
- Power Tools
- LED Lighting

Absolute Maximum Ratings T_c=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	60	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current - Continuous (T _c =25°C)	55	A
	Drain Current - Continuous (T _c =100°C)	35	A
I _{DM}	Drain Current - Pulsed (NOTE 1)	220	A
EAS	Single Pulse Avalanche Energy (NOTE 2)	61	mJ
IAS	Single Pulse Avalanche Current (NOTE 2)	35	A
P _D	Power Dissipation (T _c =25°C)	96	W
	Power Dissipation - Derate above 25°C	0.77	W/°C
T _J	Operating Junction Temperature Range	-50 to 150	°C
T _{STG}	Storage Temperature Range	-50 to 150	°C
Marking Code		NG012	

Thermal Characteristics

Symbol	Parameter	Typ.	Max	Unit
R _{θJA}	Thermal Resistance Junction to Ambient	---	62	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	1.3	°C/W

**Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	60	---	---	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=60V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=48V, V_{GS}=0V, T_J=125^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$R_{DS(ON)}$	Static Drain-Source On-Resistance (NOTE 3)	$V_{GS}=10V, I_D=10A$	---	10	12	m Ω
		$V_{GS}=4.5V, I_D=8A$	---	12	15	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.6	2.5	V
gfs	Forward Transconductance	$V_{DS}=10V, I_D=6A$	---	11.7	---	S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q_g	Total Gate Charge (NOTE 3 · 4)	$V_{DS}=30V, V_{GS}=10V, I_D=10A$	---	39.2	59	nC
Q_{gs}	Gate-Source Charge (NOTE 3 · 4)		---	5.9	9	
Q_{gd}	Gate-Drain Charge (NOTE 3 · 4)		---	8.8	14	
$T_{d(on)}$	Turn-On Delay Time (NOTE 3 · 4)	$V_{DD}=15V, V_{GS}=10V, R_G=6\Omega, I_D=1A$	---	9.6	18	ns
T_r	Rise Time (NOTE 3 · 4)		---	28.2	54	
$T_{d(off)}$	Turn-Off Delay Time (NOTE 3 · 4)		---	45.3	86	
T_f	Fall Time (NOTE 3 · 4)		---	10.9	21	
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, F=1\text{MHz}$	---	2100	3050	pF
C_{oss}	Output Capacitance		---	165	240	
C_{rss}	Reverse Transfer Capacitance		---	80	120	
Rg	Gate resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	---	1.6	3.2	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V, \text{Force Current}$	---	---	55	A
I_{SM}	Pulsed Source Current (NOTE 3)		---	---	220	A
V_{SD}	Diode Forward Voltage (NOTE 3)	$V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$	---	---	1	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=35A, R_G=25\Omega, \text{Starting } T_J=25^\circ\text{C}$.
3. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.



Characteristics Curves

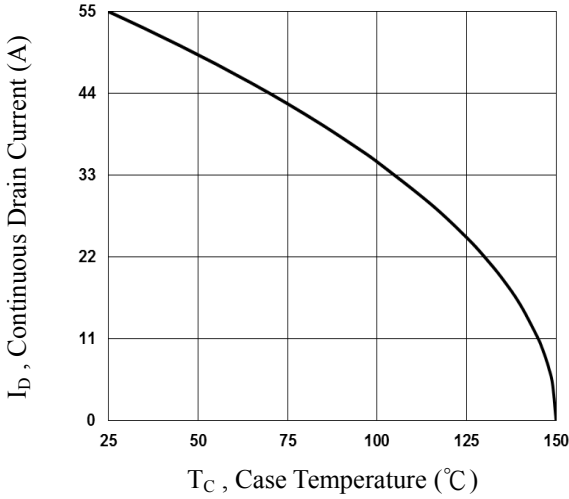


Fig.1 Continuous Drain Current vs. T_c

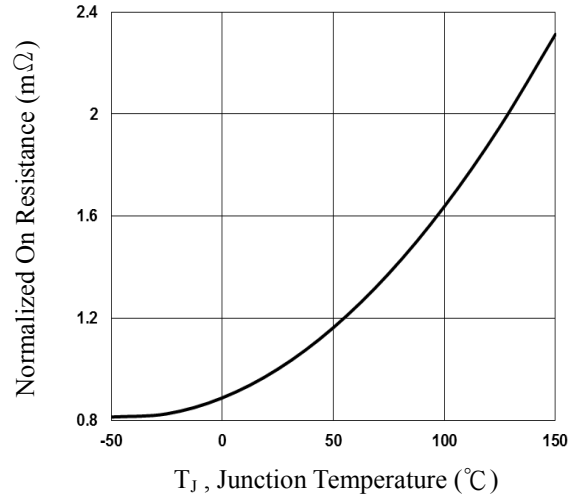


Fig.2 Normalized RDSON vs. T_j

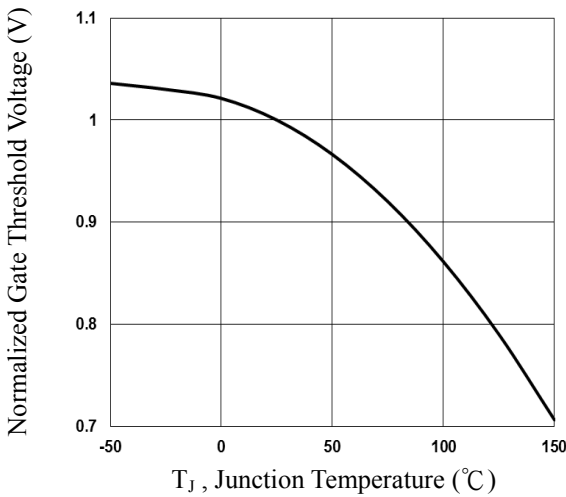


Fig.3 Normalized V_{th} vs. T_j

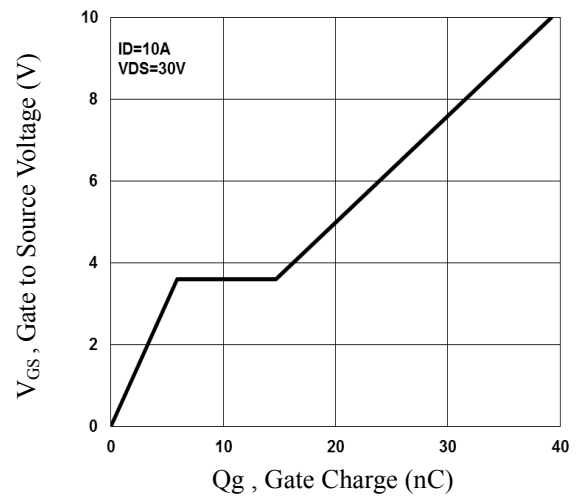


Fig.4 Gate Charge Waveform

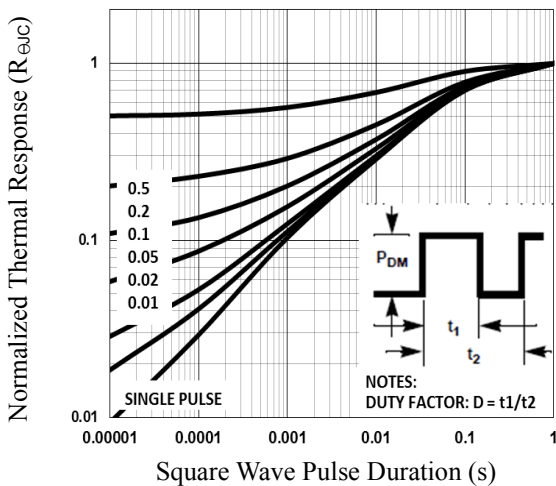


Fig.5 Normalized Transient Response

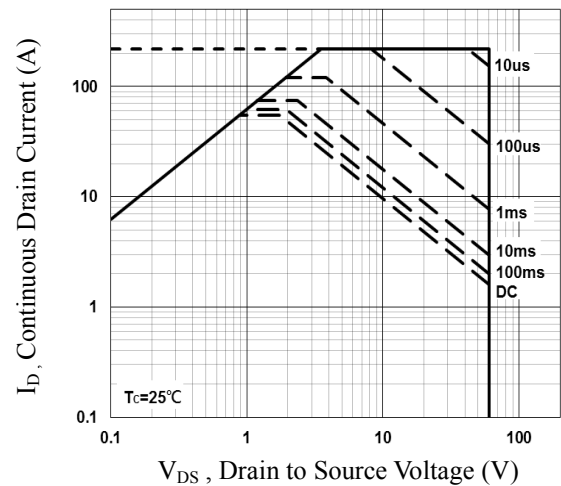


Fig.6 Maximum Safe Operation Area



Characteristics Curves

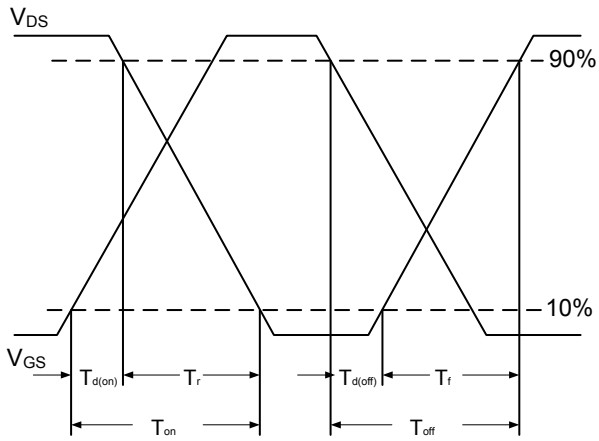


Fig.7 Switching Time Waveform

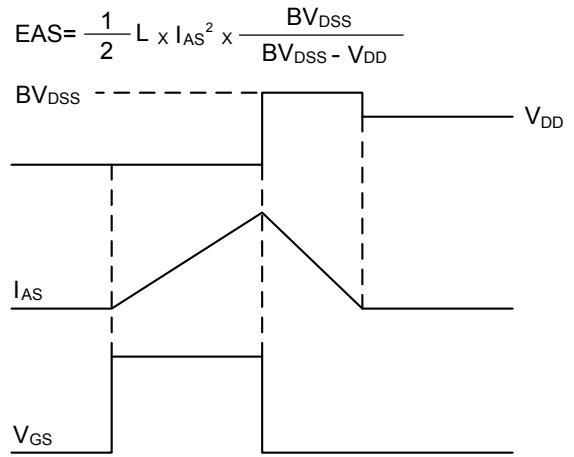
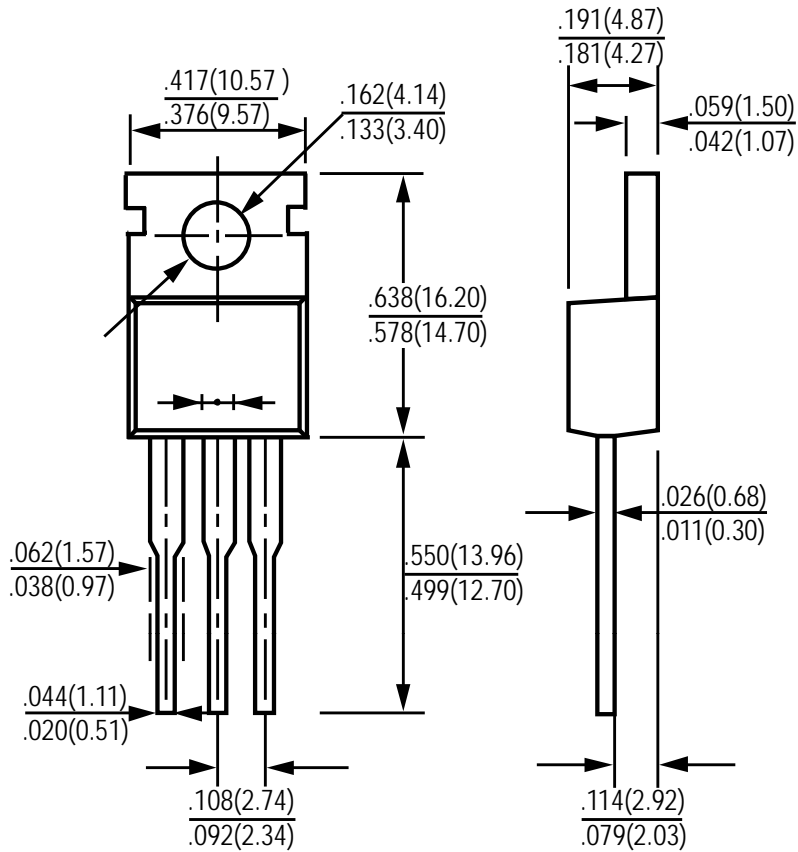


Fig.8 EAS Waveform



Package Outline Dimensions



TO-220

Dimensions in inches and (millimeters)



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